



TMT-HAO50



The TMT-HA050 hot air tool can be used for the removal of surface mount components such as SOIC, QFP, PLCC and other similar devices.

- Digital display shows temperature and air flow
- Light, portable, plug and use tool
- Uses HTN Series Hot Air Nozzles
- Convection heating allowing low pressure hot air to focus on the solder joints

TMT-HAO50 SPECIFICATIONS

Input Line Voltage:	220-240 VAC
Power:	600 Watts
Temperature Range:	100 °C - 480 °C
Pump:	Turbine Motor
Airflow (Max):	30L / min
Fuse:	250V 3A
Size (W x H x D):	65mm x 265mm
Weight:	1 KG

PACKING LIST

TMT-HA050	Hot Air Tool
HTN-D30	Nozzle 3.0mm (0.12")
HTN-D50	Nozzle 5.0mm (0.20")
HTN-D80	Nozzle 8.0mm (0.31")
HTN-D100	Nozzle 10.0mm (0.39")

CERTIFICATION MARK



TMT-HA200 SPECIFICATIONS

Input Line Voltage:	220-240 VAC
Power:	600 Watts
Temperature Range:	100 °C - 480 °C
Pump:	Turbine Fan
Airflow (Max):	35L / min
Fuse:	250V 3A
Size (W x H x D):	112mm x 205mm x 117mm
Weight:	2.40 KG

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The TMT-HA200 hot air tool can be used for the removal and reflow of surface mount components such as SOIC, QFP PLCC and other similar devices.

- Large selection of high quality nozzles
- Adjustable, easy to use temp and air control knobs
- ▶ Uses HTN Series Hot Air Nozzles
- Auto sleep activated when hot air tool is placed in the holder.

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